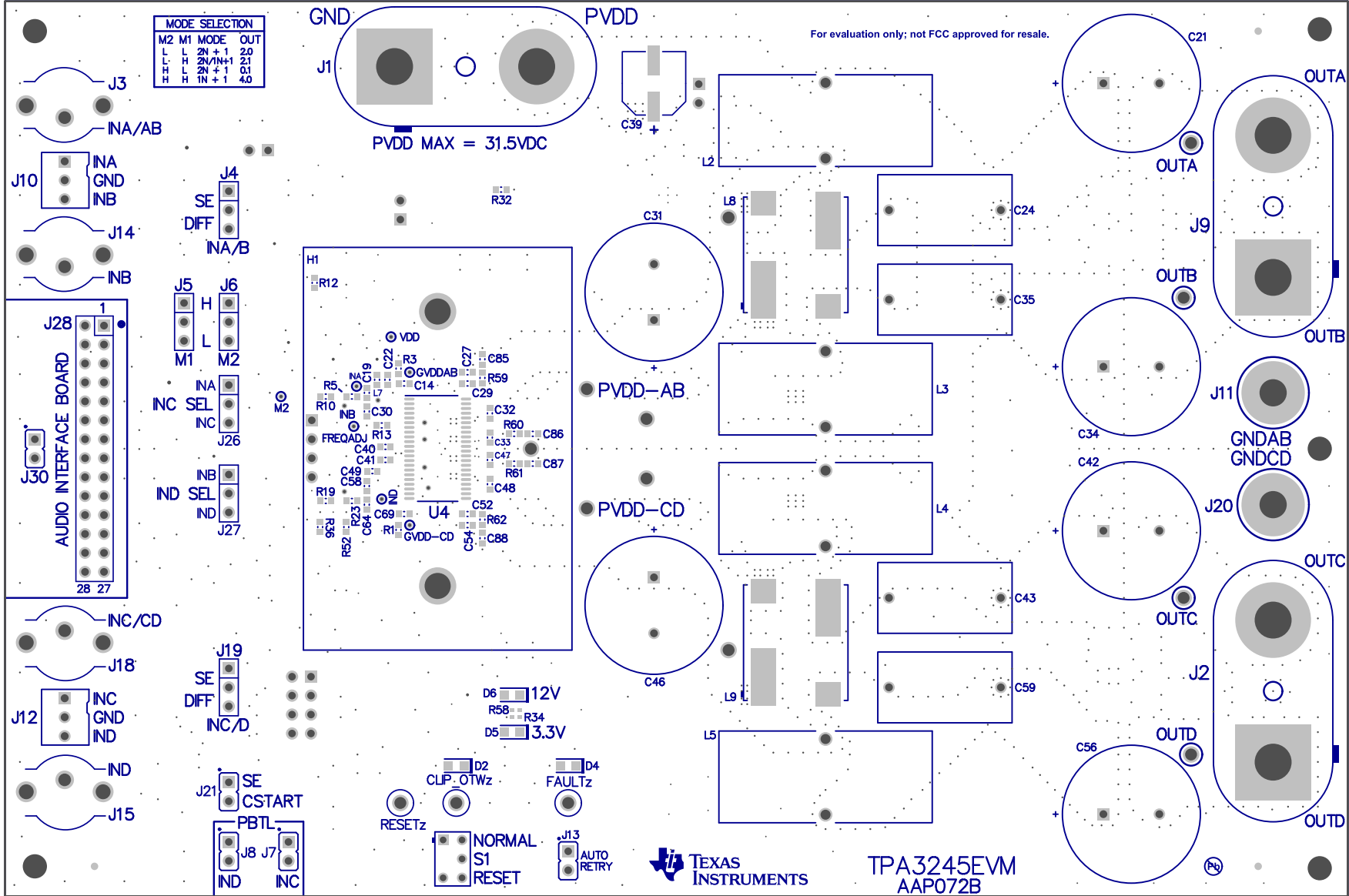
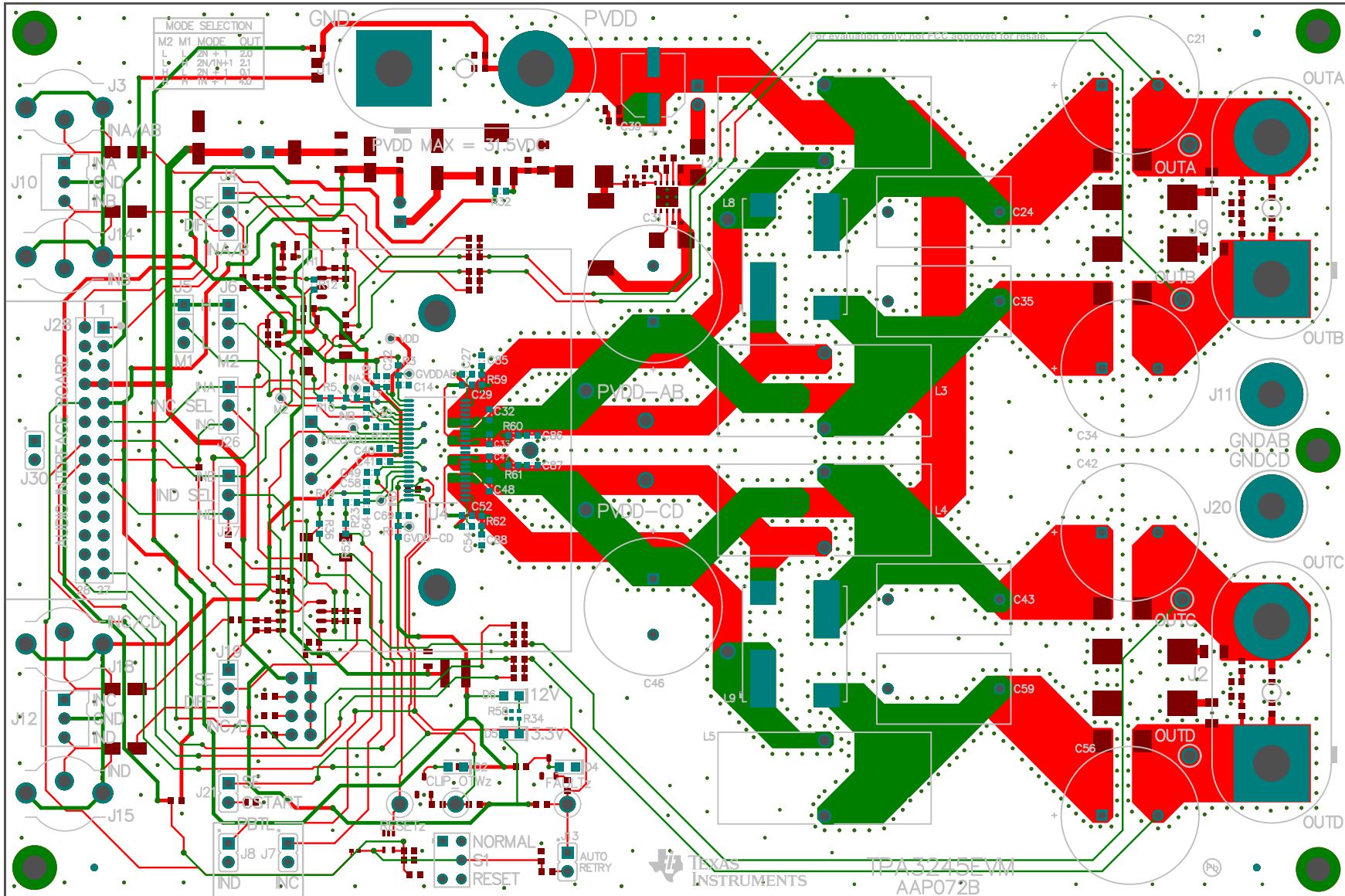


Top Overlay

Top Layer
Top Layer

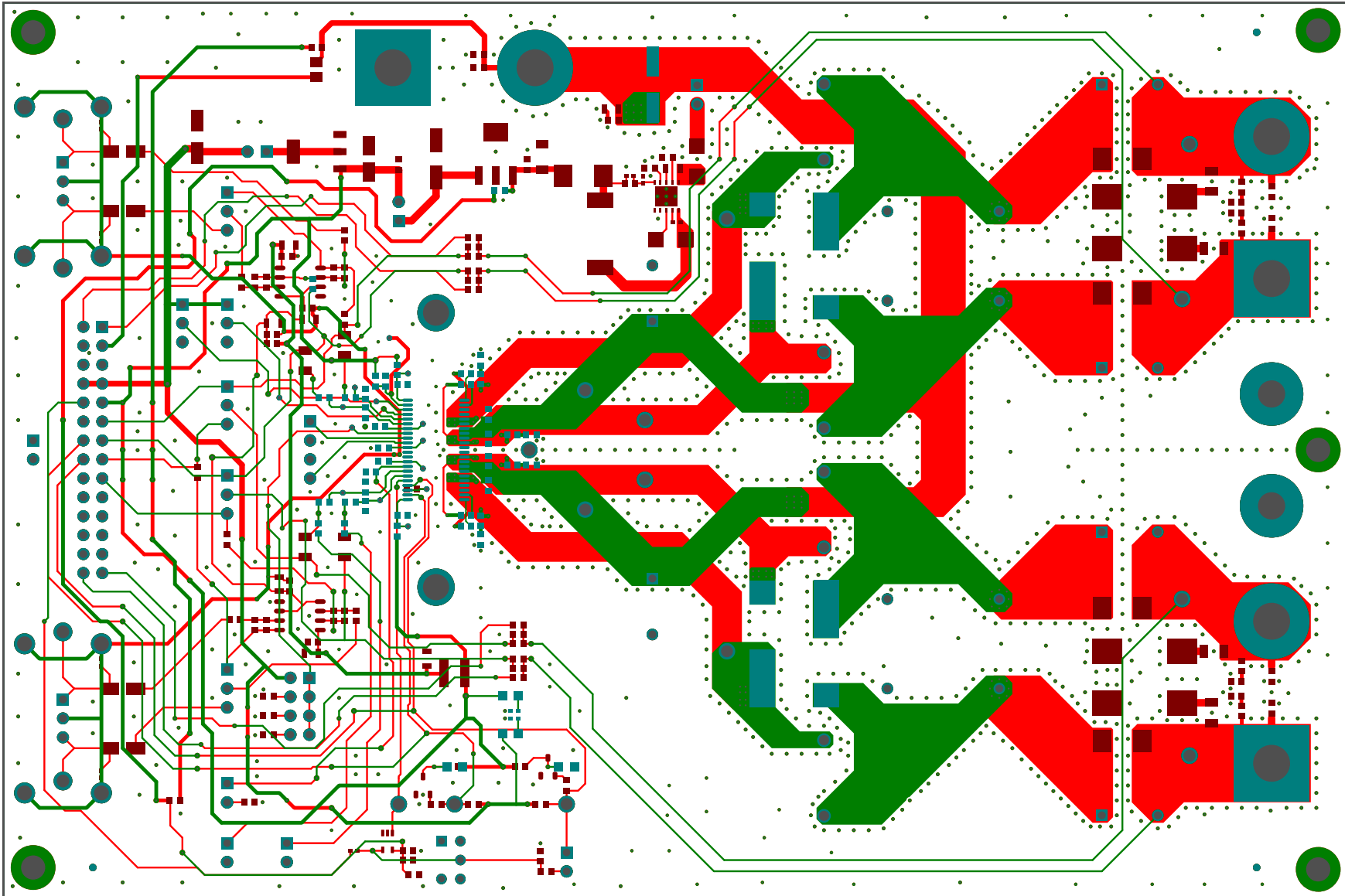




Top Overlay

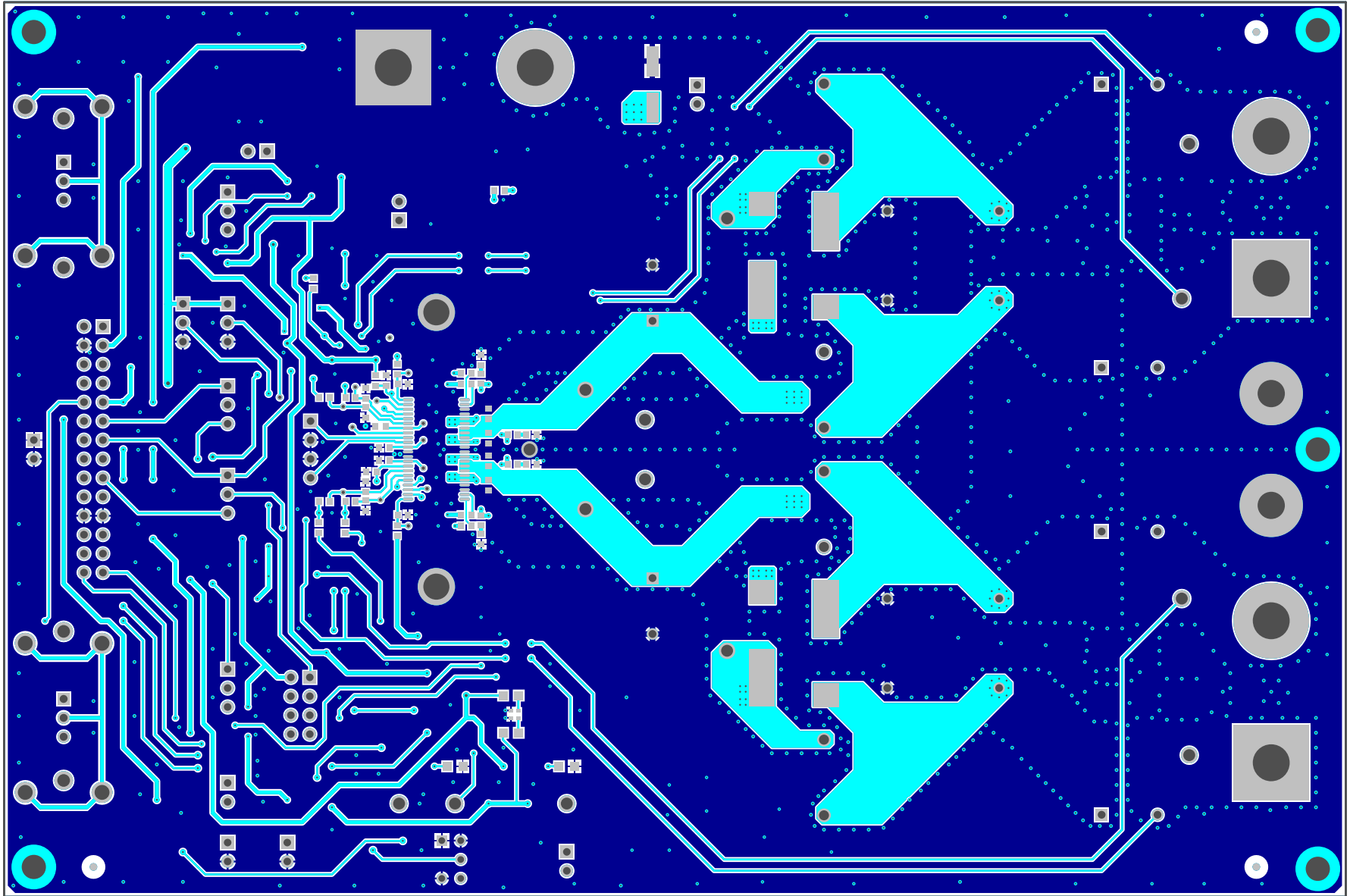
Top Layer

Bottom Layer

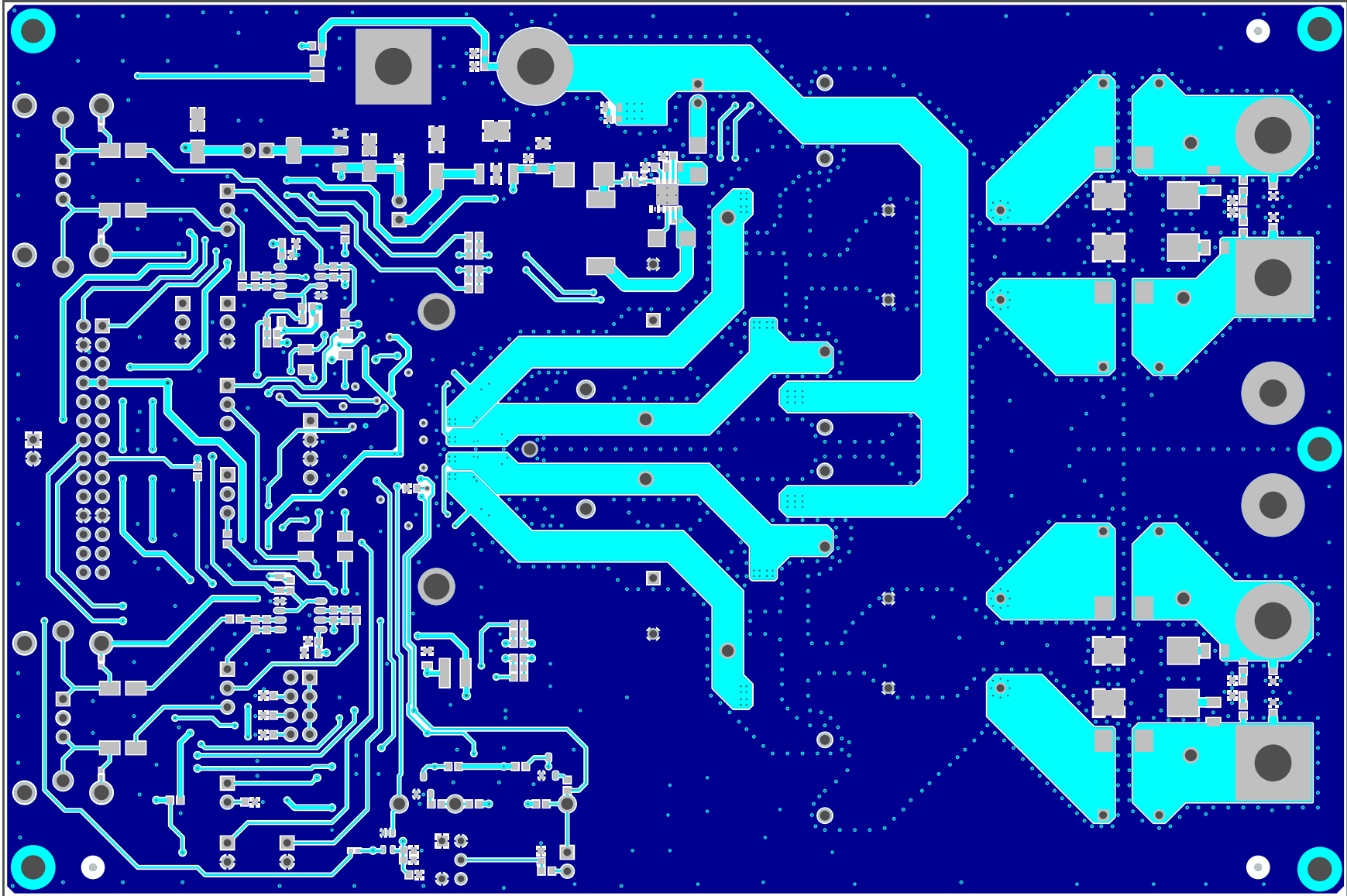


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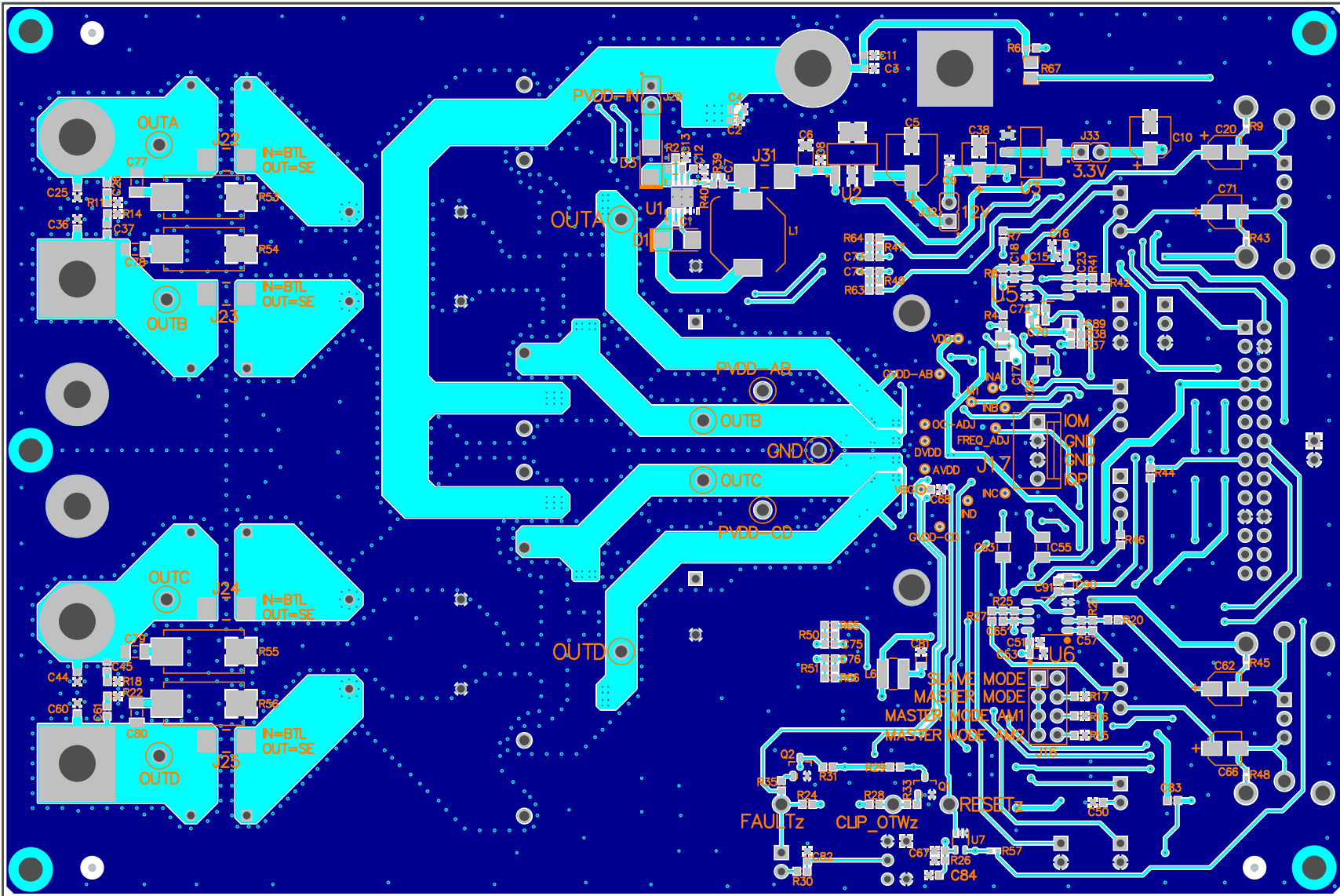
Bottom Layer



Top Layer
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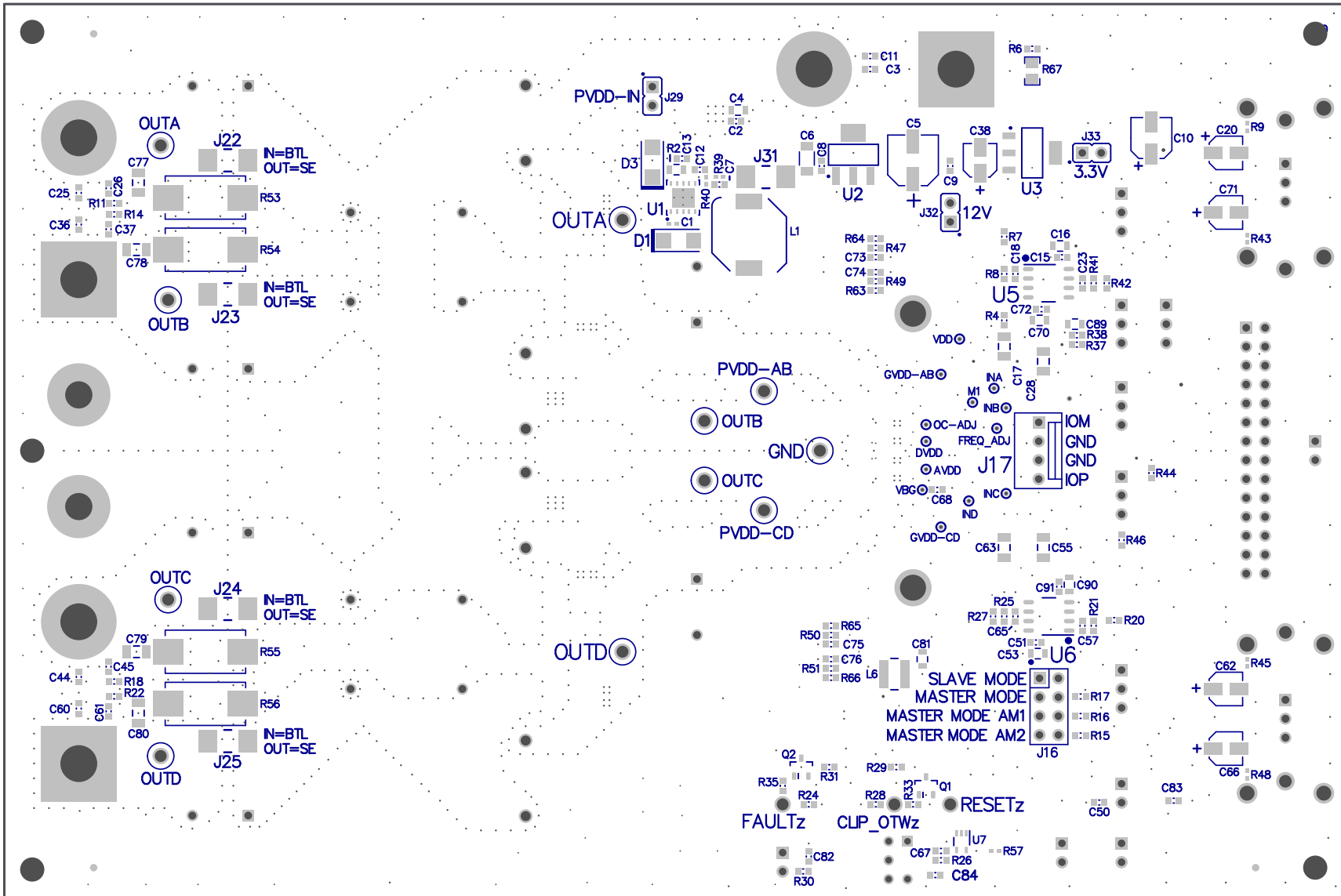


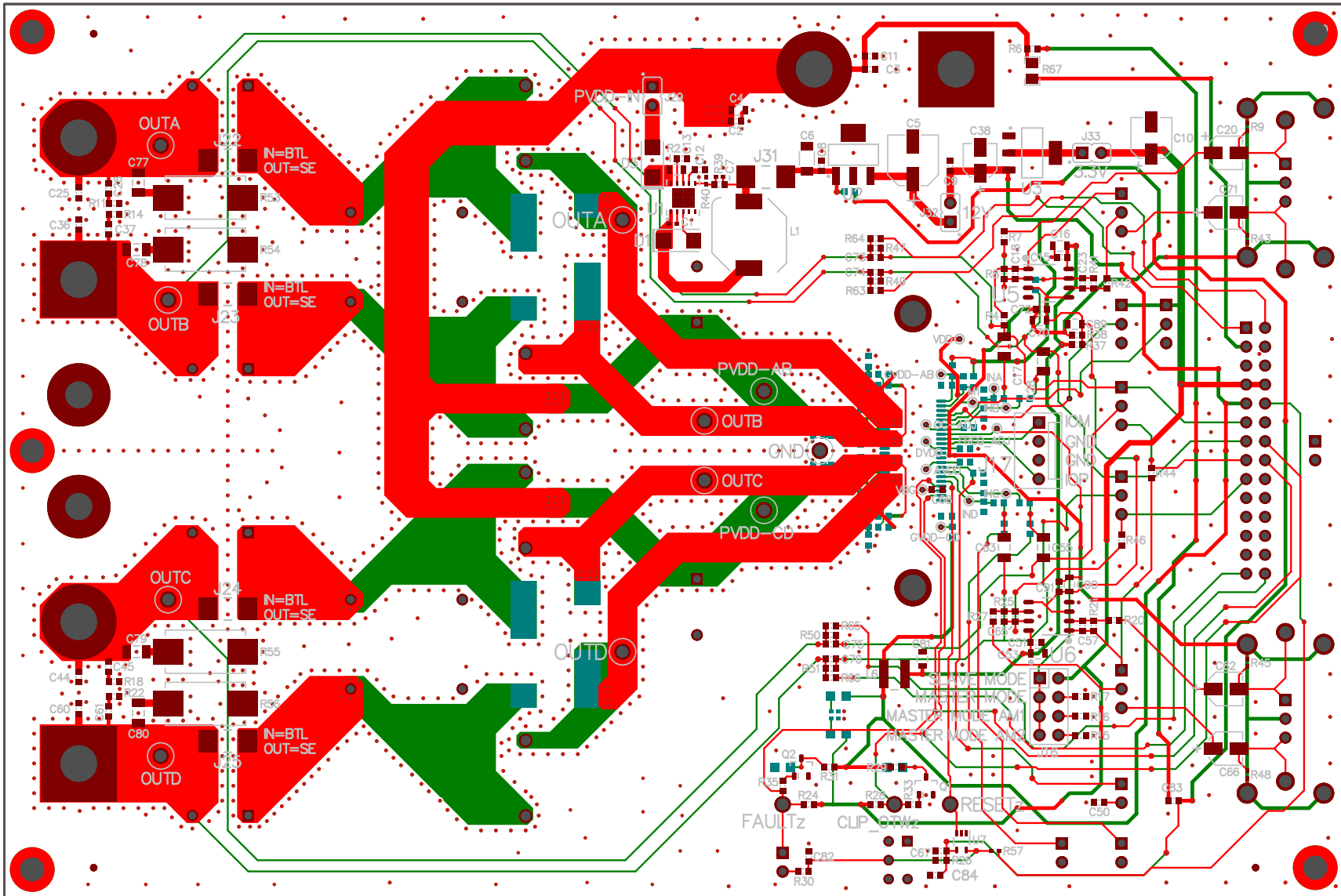
Bottom Layer
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Bottom Overlay

Bottom Layer
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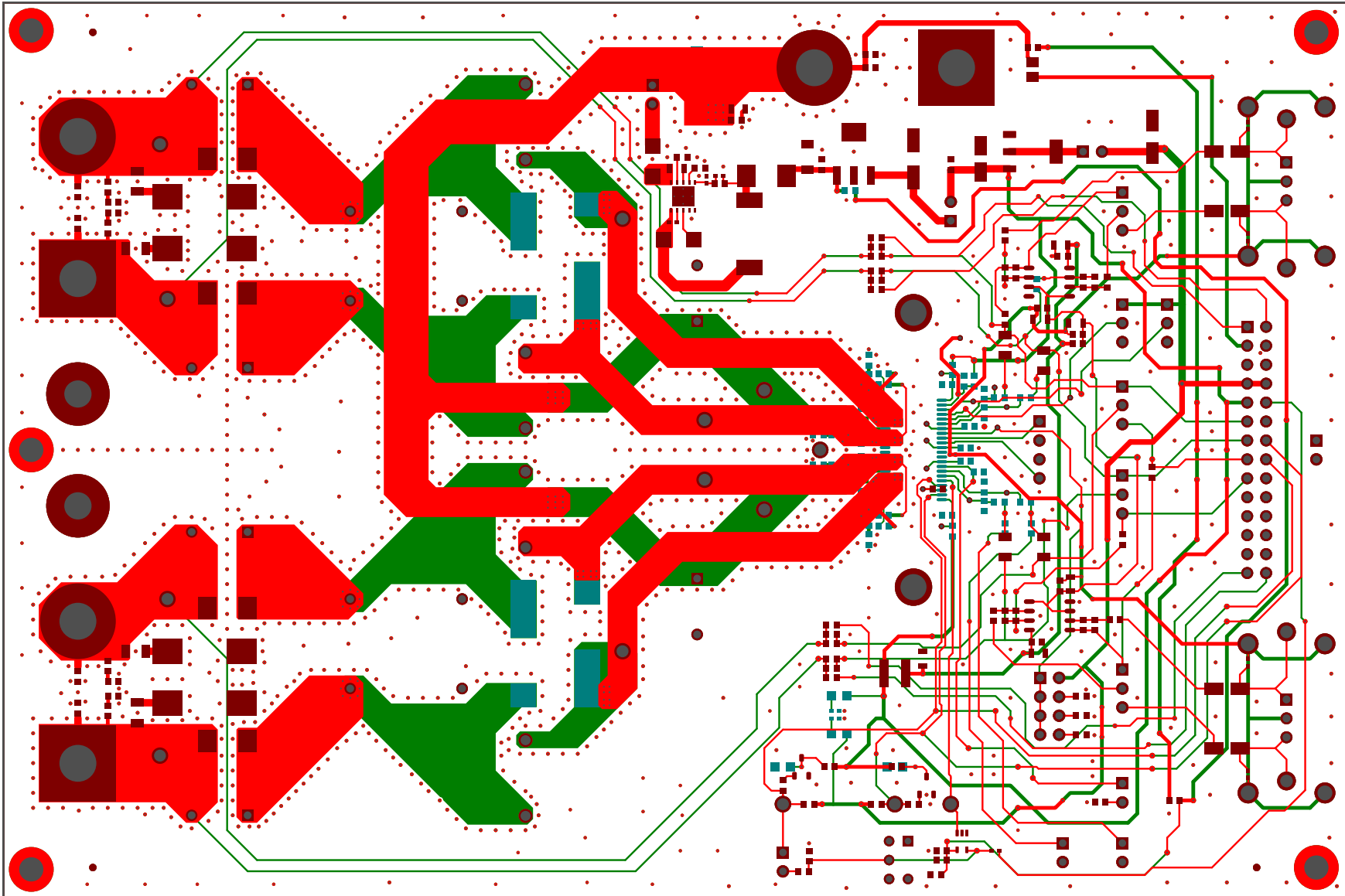




Bottom Overlay

Top Layer

Bottom Layer



Top Layer

Bottom Layer

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